

## PROFET™ +24 V

#### BTS40K2-1ENC

### Smart High-Side Power Switch Single Channel, 200 $m\Omega$



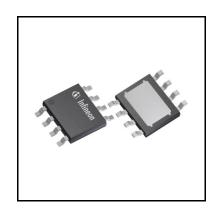


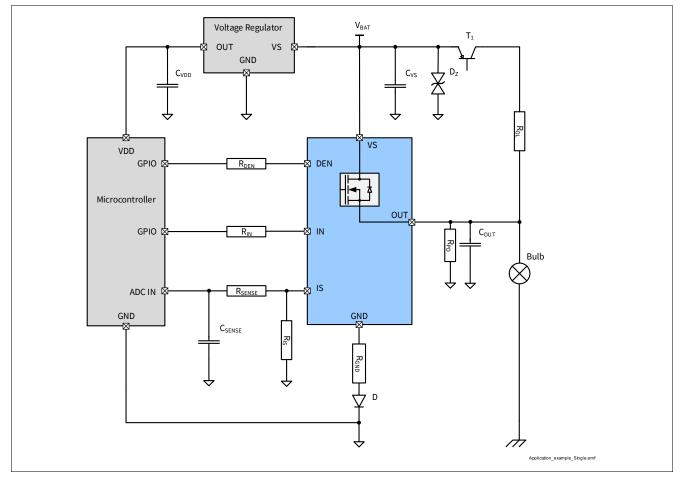
Package	PG-TDSO-8
Marking	40K2-ENC

## 1 Overview

### **Application**

- Suitable for resistive, inductive and capacitive loads
- Replaces electromechanical relays, fuses and discrete circuits





**Application Diagram with BTS40K2-1ENC** 

## PROFET™ +24 V

#### BTS40K2-1ENC



#### **Overview**

#### **Basic Features**

- Single channel device
- Very low stand-by current
- 3.3 V and 5 V compatible logic inputs
- Electrostatic discharge protection (ESD)
- Optimized electromagnetic compatibility
- Logic ground independent from load ground
- Very low power DMOS leakage current in OFF state
- Green product (RoHS compliant)
- **AEC** qualified

#### **Description**

The BTS40K2-1ENC is a 200 mΩ single channel Smart High-Side Power Switch, embedded in a PG-TDSO-8, Exposed Pad package, providing protective functions and diagnosis. The power transistor is built by an N-channel vertical power MOSFET with charge pump. The device is integrated in Smart6 technology. It is specially designed to drive relays and lamps up to 1x R5W 12V, as well as LEDs.

Table 1 **Product Summary** 

Parameter	Symbol	Value
Operating voltage range	$V_{S(OP)}$	5 V 36 V
Maximum supply voltage	$V_{S(LD)}$	65 V
Maximum ON state resistance at $T_J = 150$ °C	$R_{\rm DS(ON)}$	400 mΩ
Nominal load current	I <sub>L(NOM)</sub>	1.5 A
Typical current sense ratio	k <sub>ILIS</sub>	300
Minimum current limitation	/ <sub>L5(SC)</sub>	5 A
Maximum standby current with load at $T_J = 25$ °C	I <sub>S(OFF)</sub>	500 nA

#### **Diagnostic Functions**

- Proportional load current sense
- Open load detection in ON and OFF
- Short circuit to battery and ground indication
- Overtemperature switch off detection
- Stable diagnostic signal during short circuit
- Enhanced  $k_{\text{ILIS}}$  dependency with temperature and load current

### **Protection Functions**

- Stable behavior during undervoltage
- Reverse polarity protection with external components
- Secure load turn-off during logic ground disconnection with external components
- Overtemperature protection with restart
- Overvoltage protection with external components
- Enhanced short circuit operation





## 2 Block Diagram

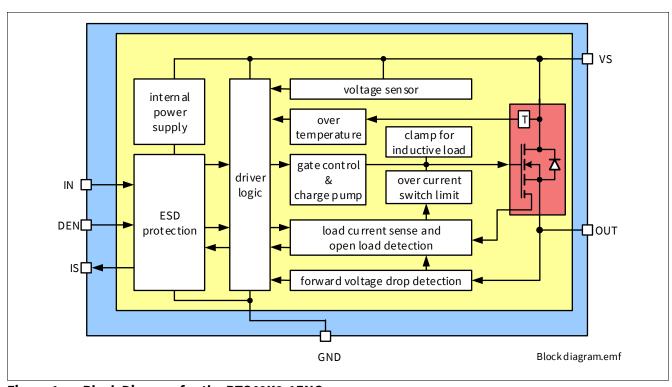


Figure 1 Block Diagram for the BTS40K2-1ENC

#### **Pin Configuration**



#### **Pin Configuration** 3

#### **Pin Assignment** 3.1

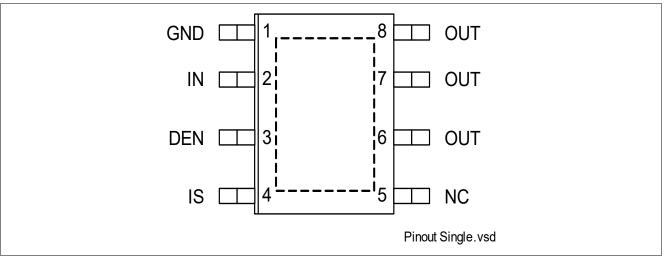


Figure 2 **Pin Configuration** 

#### **Pin Definitions and Functions** 3.2

**Pin Definitions and Functions** Table 2

Pin	Symbol	Function
1	GND	GrouND: Ground connection
2	IN	INput channel: Input signal for channel activation
3	DEN	<b>Diagnostic ENable:</b> Digital signal to enable/disable the diagnosis of the device
4	IS	Sense: Sense current of the selected channel
5	NC	Not Connected: No internal connection to the chip
6, 7, 8	OUT	<b>OUTput:</b> Protected high side power output channel <sup>1)</sup>
Cooling Tab	VS	Voltage Supply: Battery voltage

<sup>1)</sup> All output pins must be connected together on the PCB. All pins of the output are internally connected together. PCB traces have to be designed to withstand the maximum current which can flow.



### **Pin Configuration**

## 3.3 Voltage and Current Definition

Figure 3 shows all terms used in this data sheet with the associated convention for positive values.

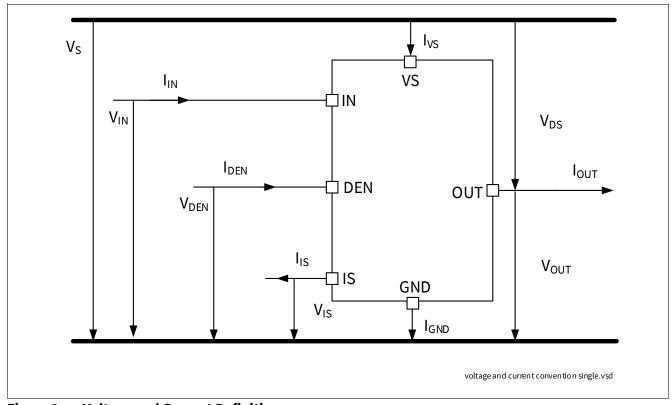


Figure 3 Voltage and Current Definition

# infineon

#### **General Product Characteristics**

## **4** General Product Characteristics

## 4.1 Absolute Maximum Ratings

Table 3 Absolute Maximum Ratings 1)

 $T_{\rm J}$  = -40°C to 150°C; (unless specified otherwise)

Parameter	Symbol		Value	s	Unit	Note or	Number
		Min.	Тур.	Max.		Test Condition	
Supply Voltages			<u>.</u>				
Supply voltage	$V_{S}$	-0.3	_	48	V	_	P_4.1.1
Reverse polarity voltage	-V <sub>S(REV)</sub>	0	-	28	V	t < 2  min $T_A = 25^{\circ}\text{C}$ $R_L \ge 25 \Omega$ $Z_{\text{GND}} = \text{Diode} + 27 \Omega$	P_4.1.2
Supply voltage for short circuit protection	V <sub>BAT(SC)</sub>	0	-	36	V	$R_{\rm Supply} = 10~{\rm m}\Omega$ $L_{\rm Supply} = 5~{\rm \mu H}$ $R_{\rm ECU} = 20~{\rm m}\Omega$ $R_{\rm Cable} = 16~{\rm m}\Omega/{\rm m}$ $L_{\rm Cable} = 1~{\rm \mu H/m}$ , $l = 0~{\rm or}~5~{\rm m}$ See Chapter 6 and Figure 28	P_4.1.3
Supply voltage for Load dump protection	$V_{S(LD)}$	-	-	65	V	$^{2)}R_1 = 2 \Omega$ $R_L = 25 \Omega$	P_4.1.12
Short Circuit Capability			<u>.</u>				
Permanent short circuit IN pin toggles	$n_{RSC1}$	_	-	100	k cycles	$^{3)}t_{ON} = 300 \text{ ms}$	P_4.1.4
Input Pins							
Voltage at INPUT pin	$V_{IN}$	-0.3 -	-	6 7	V	- t < 2 min	P_4.1.13
Current through INPUT pin	I <sub>IN</sub>	-2	-	2	mA	_	P_4.1.14
Voltage at DEN pin	$V_{DEN}$	-0.3 -	-	6 7	V	- t< 2 min	P_4.1.15
Current through DEN pin	I <sub>DEN</sub>	-2	_	2	mA	_	P_4.1.16
Sense Pin							
Voltage at IS pin	$V_{IS}$	-0.3	-	$V_{S}$	V	_	P_4.1.19
Current through IS pin	I <sub>IS</sub>	-25	_	50	mA	_	P_4.1.20
Power Stage	•	1	ı	l .			
Load current	<i>I</i> L	-	_	I <sub>L5(SC)</sub>	Α	_	P_4.1.21
Power dissipation (DC)	P <sub>TOT</sub>	-	-	1.8	W	T <sub>A</sub> = 85°C T <sub>J</sub> < 150°C	P_4.1.22

## PROFET™ +24 V

#### BTS40K2-1ENC



#### **General Product Characteristics**

### Table 3 Absolute Maximum Ratings 1)

 $T_1 = -40$ °C to 150°C; (unless specified otherwise)

Parameter	Symbol		Value	s	Unit	Note or Test Condition	Number
		Min.	Тур.	Max.			
Maximum energy dissipation Single pulse	E <sub>AS</sub>	-	-	20	mJ	$I_{L(0)} = 1 \text{ A}$ $T_{J(0)} = 150^{\circ}\text{C}$ $V_{S} = 13.5 \text{ V}$	P_4.1.23
Maximum Energy dissipation repetitive pulse	E <sub>AR</sub>	-	-	50	mJ	1 Mio cycles $T_A < 105$ °C $V_S = 13.5$ V $I_{L(0)} = 350$ mA	P_4.1.25
Voltage at power transistor	$V_{\mathrm{DS}}$	_	-	65	V	-	P_4.1.26
Currents							
Current through ground pin	$I_{GND}$	-20 -150	_	20 20	mA	- t < 2 min	P_4.1.27
Temperatures	1			 			
Junction temperature	$T_{J}$	-40	_	150	°C	_	P_4.1.28
Storage temperature	$T_{\rm STG}$	-55	_	150	°C	-	P_4.1.30
ESD Susceptibility	1				- 1	1	
ESD susceptibility (all pins)	$V_{ESD}$	-2	_	2	kV	<sup>4)</sup> HBM	P_4.1.31
ESD susceptibility OUT Pin vs. GND and $V_{\rm S}$ connected	V <sub>ESD</sub>	-4	-	4	kV	<sup>4)</sup> HBM	P_4.1.32
ESD susceptibility	V <sub>ESD</sub>	-500	_	500	٧	<sup>5)</sup> CDM	P_4.1.33
ESD susceptibility pin (corner pins)	V <sub>ESD</sub>	-750	-	750	V	<sup>5)</sup> CDM	P_4.1.34

- 1) Not subject of production test. Specified by design.
- 2)  $V_{S(LD)}$  is setup without the DUT connected to the generator per ISO 7637-1.
- 3) EOL tests according to AECQ100-012. Threshold limit for short circuit failures: 100 ppm. Please refer to the legal disclaimer for short-circuit capability on the last page of this document.
- 4) ESD susceptibility, Human Body Model "HBM", according to AEC Q100-002.
- 5) ESD susceptibility, Charge Device Model "CDM", according to AEC Q100-011.

#### **Notes**

- 1. Stresses above the ones listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
- 2. Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

#### BTS40K2-1ENC

#### **General Product Characteristics**

#### **Functional Range** 4.2

Functional Range  $T_J$  = -40°C to 150°C; (unless specified otherwise) Table 4

Parameter	Symbol		Value	S	Unit	Note or	Number
		Min.	Тур.	Max.		<b>Test Condition</b>	
Nominal operating voltage	$V_{NOM}$	8	13.5	18	V	-	P_4.2.1
Extended operating voltage	V <sub>S (OP)</sub>	5	-	48	V	$^{2)} V_{IN} = 4.5 \text{ V}$ $R_{L} = 25 \Omega$ $V_{DS} < 0.5 \text{ V}$	P_4.2.2
Minimum functional supply voltage	$V_{S(OP)_{-}MIN}$	3.8	4.3	5	V	<sup>1)</sup> $V_{IN} = 4.5 \text{ V}$ $R_L = 25 \Omega$ From $I_{OUT} = 0 \text{ A}$ to $V_{DS} < 0.5 \text{ V}$ ; see <b>Figure 15</b>	P_4.2.3
Undervoltage shutdown	V <sub>S (UV)</sub>	3	3.5	4.1	V	1) $V_{IN} = 4.5 \text{ V}$ $V_{DEN} = 0 \text{ V}$ $R_{L} = 25 \Omega$ From $V_{DS} < 1 \text{ V}$ ; to $I_{OUT} = 0 \text{ A}$ See <b>Figure 15</b>	P_4.2.4
Undervoltage shutdown hysteresis	V <sub>S(UV)_HYS</sub>	-	850	_	mV	2) _	P_4.2.13
Operating current channel active	I <sub>GND_1</sub>	_	6	9	mA	$V_{IN} = 5.5 \text{ V}$ $V_{DEN} = 5.5 \text{ V}$ Device in $R_{DS(ON)}$ $V_{S} = 18 \text{ V}$	P_4.2.5
Standby current for whole device with load	I <sub>S (OFF)</sub>	-	0.1	0.5	μΑ	<sup>1)</sup> $V_{\rm S} = 18 \text{ V}$ $V_{\rm OUT} = 0 \text{ V}$ $V_{\rm IN}$ floating $V_{\rm DEN}$ floating $T_{\rm J} \le 85^{\circ}\text{C}$	P_4.2.7
Maximum standby current for whole device with load	I <sub>S (OFF)_150</sub>	_	-	5	μΑ	$V_{\rm S}$ = 18 V $V_{\rm OUT}$ = 0 V $V_{\rm IN}$ floating $V_{\rm DEN}$ floating $T_{\rm J}$ = 150°C	P_4.2.10
Standby current for whole device with load, diagnostic active	I <sub>S (OFF_D EN)</sub>	-	0.6	-	mA	$^{2)}$ $V_{\rm S}$ = 18 V $V_{\rm OUT}$ = 0 V $V_{\rm IN}$ floating $V_{\rm DEN}$ = 5.5 V	P_4.2.8

<sup>1)</sup> Test at  $T_J = -40^{\circ}$ C only

<sup>2)</sup> Not subject to production test. Specified by design.



#### **General Product Characteristics**

Note:

Within the functional range the IC operates as described in the circuit description. The electrical characteristics are specified within the conditions given in the related electrical characteristics table.

#### 4.3 Thermal Resistance

Table 5 Thermal Resistance

Parameter	Symbol	Symbol Va		Values		Note or	Number
		Min.	Тур.	Max.		<b>Test Condition</b>	
Junction to Case	$R_{\mathrm{thJC}}$	_	6	_	K/W	1)	P_4.3.1
Junction to ambient All channels active	$R_{thJA}$	-	39	-	K/W	1)2)	P_4.3.2

- 1) Not subject to production test. Specified by design.
- 2) Specified  $R_{\rm thJA}$  value is according to JEDEC JESD51-2,-5,-7 at natural convection on FR4 2s2p board with 1 W power dissipation at  $T_{\rm A}$ =105°C. The product (chip + package) was simulated on a 76.4 x 114.3 x 1.5 mm board with 2 inner copper layers (2 x 7  $\mu$ m Cu, 2 x 35  $\mu$ m Cu). Where applicable, a thermal via array under the exposed pad contacts the first inner copper layer. Please refer to **Figure 4**.

#### **4.3.1** PCB set up

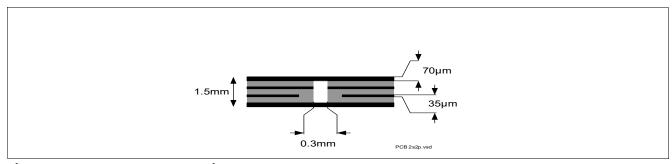


Figure 4 2s2p PCB Cross Section

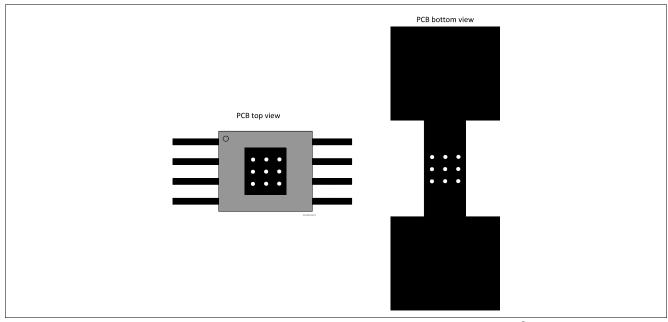
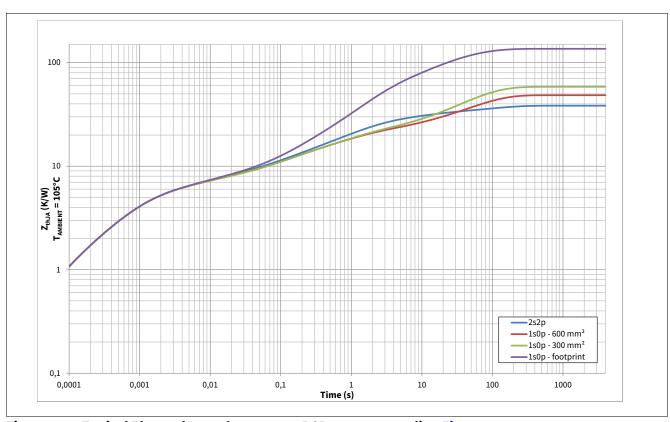


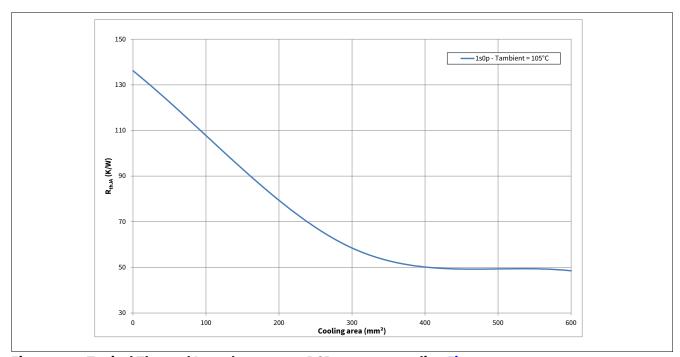
Figure 5 PC Board Top and Bottom View for Thermal Simulation with 600 mm<sup>2</sup> Cooling Area

#### **General Product Characteristics**

#### **Thermal Impedance** 4.3.2



Typical Thermal Impedance. 2s2p PCB set-up according Figure 4 Figure 6



Typical Thermal Impedance. 2s2p PCB set-up according Figure 4 Figure 7

#### **Power Stage**



## 5 Power Stage

The power stage is built using an N-channel vertical power MOSFET (DMOS) with charge pump.

#### 5.1 Output ON-State Resistance

The ON-state resistance  $R_{\rm DS(ON)}$  depends on the supply voltage as well as the junction temperature  $T_{\rm J}$ . Figure 8 shows the dependencies in terms of temperature and supply voltage for the typical ON-state resistance. The behavior in reverse polarity is described in **Chapter 6.4**.

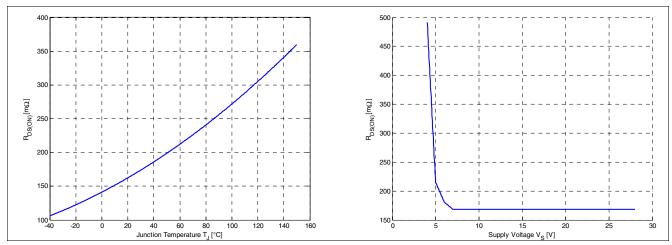


Figure 8 Typical ON-state Resistance

A high signal on the input pin (see **Chapter 8**) causes the power DMOS to switch ON with a dedicated slope, which is optimized in terms of EMC emission.

### 5.2 Turn ON/OFF Characteristics with Resistive Load

Figure 9 shows the typical timing when switching a resistive load.

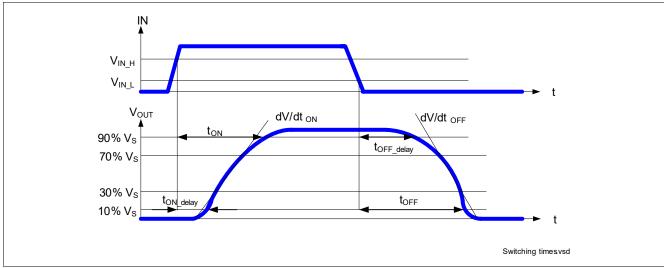


Figure 9 Switching a Resistive Load Timing

#### **Power Stage**



#### **Inductive Load 5.3**

#### 5.3.1 **Output Clamping**

When switching OFF inductive loads with high side switches, the voltage  $V_{\text{OUT}}$  drops below ground potential, because the inductance intends to continue driving the current. To prevent the destruction of the device by avalanche due to high voltages, there is a voltage clamp mechanism  $Z_{\mathrm{DS(AZ)}}$  implemented that limits negative output voltage to a certain level  $(V_S - V_{DS(AZ)})$ . Please refer to **Figure 10** and **Figure 11** for details. Nevertheless, the maximum allowed load inductance is limited.

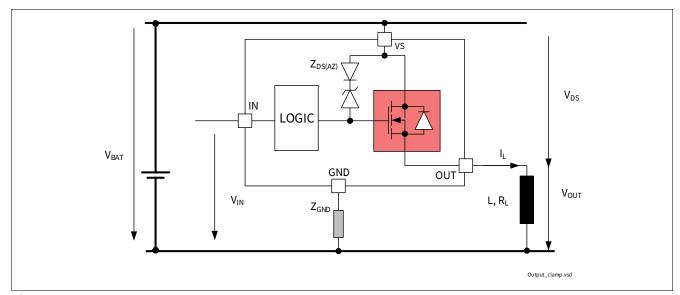
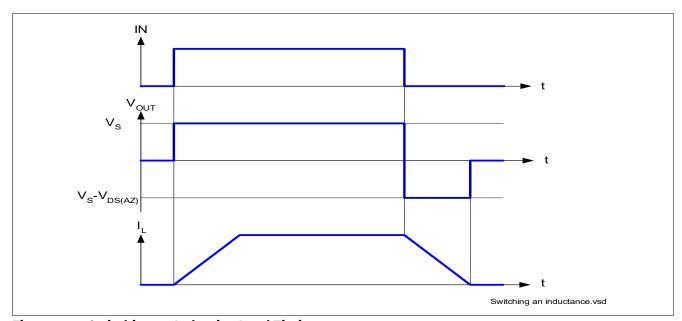


Figure 10 **Output Clamp** 



**Switching an Inductive Load Timing** 

# infineon

**Power Stage** 

#### 5.3.2 Maximum Load Inductance

During demagnetization of inductive loads, energy has to be dissipated in the BTS40K2-1ENC. This energy can be calculated with following equation:

$$E = V_{\text{DS(AZ)}} \cdot \frac{L}{R_{\text{L}}} \cdot \left[ \frac{V_{\text{S}} - V_{\text{DS(AZ)}}}{R_{\text{L}}} \cdot \ln\left(1 - \frac{R_{\text{L}} \cdot I_{\text{L}}}{V_{\text{S}} - V_{\text{DS(AZ)}}}\right) + I_{\text{L}} \right]$$
(5.1)

Following equation simplifies under the assumption of  $R_L = 0 \Omega$ .

$$E = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(1 - \frac{V_S}{V_S - V_{DS(AZ)}}\right) \tag{5.2}$$

The energy, which is converted into heat, is limited by the thermal design of the component. See **Figure 12** for the maximum allowed energy dissipation as a function of the load current.

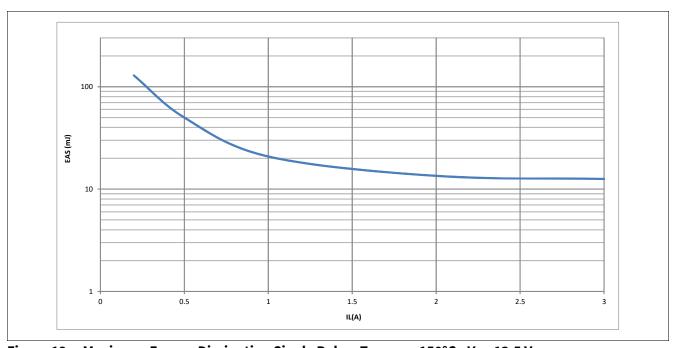
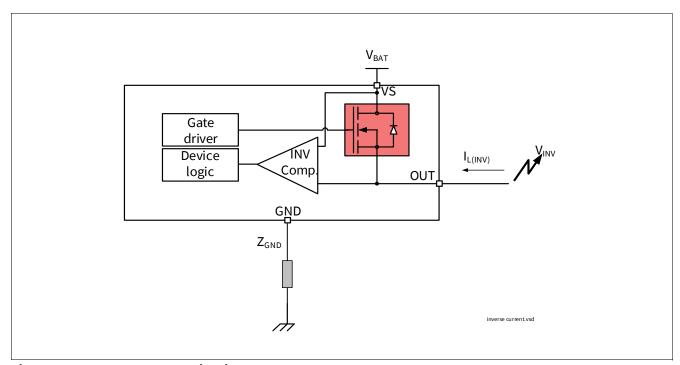


Figure 12 Maximum Energy Dissipation Single Pulse,  $T_{J\_START} = 150$ °C;  $V_S = 13.5$  V

#### **Power Stage**

#### 5.4 **Inverse Current Capability**

In case of inverse current, meaning a voltage  $V_{INV}$  at the OUTput higher than the supply voltage  $V_{S}$ , a current  $I_{INV}$  will flow from output to  $V_S$  pin via the body diode of the power transistor (please refer to **Figure 13**). The output stage follows the state of the IN pin, except if the IN pin goes from OFF to ON during inverse. In that particular case, the output stage is kept OFF until the inverse current disappears. Nevertheless, the current  $I_{INV}$ should not be higher than  $I_{L(INV)}$ . If the channel is OFF, the diagnostic will detect an open load at OFF. If the channel is ON, the diagnostic will detect open load at ON (the overtemperature signal is inhibited). At the appearance of  $V_{\rm INV}$ , a parasitic diagnostic can be observed. After, the diagnosis is valid and reflects the output state. At  $V_{\rm INV}$  vanishing, the diagnosis is valid and reflects the output state. During inverse current, no protection functions are available.



**Inverse Current Circuitry** Figure 13



#### **Power Stage**

## 5.5 Electrical Characteristics Power Stage

### Table 6 Electrical Characteristics: Power Stage

 $V_{\rm S}$  = 8 V to 18 V,  $T_{\rm J}$  = -40°C to 150°C (unless otherwise specified). Typical values are given at  $V_{\rm S}$  = 13.5 V,  $T_{\rm J}$  = 25 °C

Parameter	Symbol		Value	S	Unit	Note or	Number
		Min.	Тур.	Max.		<b>Test Condition</b>	
ON-state resistance	R <sub>DS (ON)_150</sub>	300	360	400	mΩ	$I_{L} = I_{L4} = 1 \text{ A}$ $V_{IN} = 4.5 \text{ V}$ $T_{J} = 150 ^{\circ}\text{C}$ See <b>Figure 8</b>	P_5.5.1
ON-state resistance	R <sub>DS (ON)_25</sub>	-	200	_	mΩ	<sup>1)</sup> $T_J = 25$ °C	P_5.5.21
Nominal load current	I <sub>L(NOM)1</sub>	-	1.5	_	Α	<sup>1)</sup> T <sub>A</sub> = 85°C T <sub>J</sub> < 150°C	P_5.5.2
Output voltage drop limitation at small load currents	V <sub>DS (NL)</sub>	-	10	22	mV	$I_{\rm L} = I_{\rm L0} = 25  \rm mA$	P_5.5.4
Drain to source clamping voltage $V_{DS(AZ)} = [V_S - V_{OUT}]$	V <sub>DS (AZ)</sub>	65	70	75	V	I <sub>DS</sub> = 20 mA	P_5.5.5
Output leakage current T <sub>J</sub> ≤ 85°C	I <sub>L (OFF)</sub>	_	0.1	0.5	μΑ	$V_{IN}$ floating $V_{OUT} = 0 \text{ V}$ $T_{J} \le 85^{\circ}\text{C}$	P_5.5.6
Output leakage current T <sub>J</sub> = 150°C	I <sub>L (OFF)_150</sub>	_	1	5	μΑ	$V_{IN}$ floating $V_{OUT} = 0 \text{ V}$ $T_{J} = 150^{\circ}\text{C}$	P_5.5.8
Inverse current capability	I <sub>L(INV)</sub>	-	1	_	А	1) V <sub>S</sub> < V <sub>OUTX</sub> See <b>Figure 13</b>	P_5.5.9
Slew rate 30% to 70% V <sub>S</sub>	dV/dt <sub>ON</sub>	0.20	0.47	1.0	V/µs	$R_{\rm L} = 25 \Omega$ $V_{\rm S} = 13.5 \rm V$	P_5.5.11
Slew rate $70\%$ to $30\%$ $V_{\rm S}$	-dV/dt <sub>OFF</sub>	0.20	0.47	1.0	V/µs	See Figure 9	P_5.5.12
Slew rate matching $dV/dt_{ON}$ - $dV/dt_{OFF}$	∆dV/ dt	-0.15	0	0.15	V/µs		P_5.5.13
Turn-ON time to $V_{\text{OUT}} = 90\% V_{\text{S}}$	t <sub>ON</sub>	20	70	120	μs		P_5.5.14
Turn-OFF time to $V_{\text{OUT}} = 10\% V_{\text{S}}$	t <sub>OFF</sub>	20	70	120	μs		P_5.5.15
Turn-ON / OFF matching $t_{\text{OFF}}$ - $t_{\text{ON}}$	$\Delta t_{\sf SW}$	-50	0	50	μs		P_5.5.16
Turn-ON time to $V_{\text{OUT}} = 10\% V_{\text{S}}$	t <sub>ON_delay</sub>	10	40	70	μs		P_5.5.17
Turn-OFF time to $V_{OUT} = 90\% V_{S}$	t <sub>OFF_delay</sub>	10	40	70	μs		P_5.5.18

# PROFET™ +24 V

## BTS40K2-1ENC



#### **Power Stage**

#### **Electrical Characteristics: Power Stage (cont'd)** Table 6

 $V_{\rm S}$  = 8 V to 18 V,  $T_{\rm J}$  = -40°C to 150°C (unless otherwise specified).

Typical values are given at  $V_S = 13.5 \text{ V}$ ,  $T_J = 25 \text{ }^{\circ}\text{C}$ 

Parameter	Symbol	Value	S	Unit	Note or	Number	
		Min.	Тур.	Max.		<b>Test Condition</b>	
Switch ON energy	E <sub>ON</sub>	-	70	-	μJ	$^{1)}$ R <sub>L</sub> = 25 Ω V <sub>OUT</sub> = 90% V <sub>S</sub> V <sub>S</sub> = 18 V	P_5.5.19
Switch OFF energy	E <sub>OFF</sub>	-	80	-	μJ	$^{1)}$ R <sub>L</sub> = 25 Ω V <sub>OUT</sub> = 10% V <sub>S</sub> V <sub>S</sub> = 18 V	P_5.5.20

<sup>1)</sup> Not subject to production test, specified by design.

<sup>2)</sup> Test at  $T_J = -40$ °C only



#### **6** Protection Functions

The device provides integrated protection functions. These functions are designed to prevent the destruction of the IC from fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are designed for neither continuous nor repetitive operation.

#### 6.1 Loss of Ground Protection

In case of loss of the module ground and the load remains connected to ground, the device protects itself by automatically turning OFF (when it was previously ON) or remains OFF, regardless of the voltage applied on IN pins.

In case of loss of device ground, it's recommended to use input resistors between the microcontroller and the BTS40K2-1ENC to ensure switching OFF the channel.

In case of loss of module or device ground, a current  $(I_{OUT(GND)})$  can flow out of the DMOS. **Figure 14** sketches the situation.

 $Z_{GND}$  is recommended to be a resistor in series to a diode .

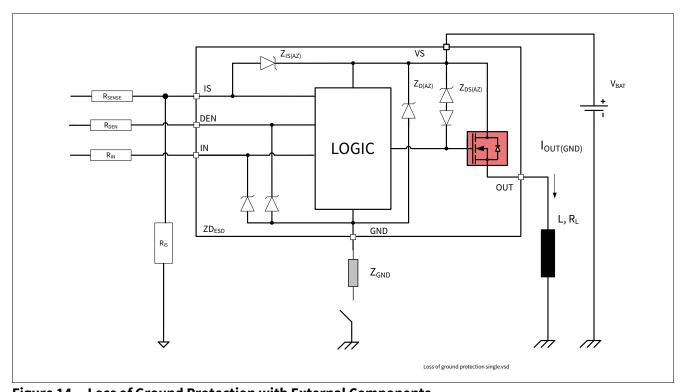


Figure 14 Loss of Ground Protection with External Components

#### 6.2 Undervoltage Protection

Between  $V_{S(UV)}$  and  $V_{S(OP)}$ , the undervoltage mechanism is triggered.  $V_{S(OP)}$  represents the minimum voltage where the switching ON and OFF can takes place. VS(UV) represents the minimum voltage the switch can hold ON. If the supply voltage is below the undervoltage mechanism  $V_{S(UV)}$ , the device is OFF (turns OFF). As soon as the supply voltage is above the undervoltage mechanism  $V_{S(OP)}$ , then the device can be switched ON. When the switch is ON, protection functions are operational. Nevertheless, the diagnosis is not guaranteed until  $V_S$  is in the  $V_{NOM}$  range. Figure 15 sketches the undervoltage mechanism.

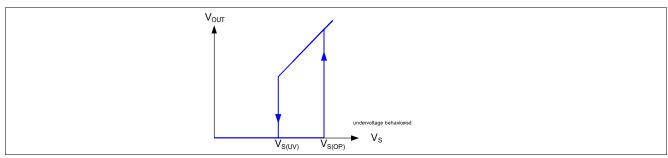


Figure 15 **Undervoltage Behavior** 

#### 6.3 **Overvoltage Protection**

There is an integrated clamp mechanism for overvoltage protection  $(Z_{D(AZ)})$ . To guarantee this mechanism operates properly in the application, the current in the Zener diode has to be limited by a ground resistor. Figure 16 shows a typical application to withstand overvoltage issues. In case of supply voltage higher than  $V_{S(AZ)}$ , the power transistor switches ON and in addition the voltage across the logic section is clamped. As a result, the internal ground potential rises to  $V_S - V_{S(AZ)}$ . Due to the ESD Zener diodes, the potential at pin IN and DEN rises almost to that potential, depending on the impedance of the connected circuitry. In the case the device was ON, prior to overvoltage, the BTS40K2-1ENC remains ON. In the case the BTS40K2-1ENC was OFF, prior to overvoltage, the power transistor can be activated. In the case the supply voltage is in above  $V_{\text{BAT(SC)}}$ and below  $V_{DS(AZ)}$ , the output transistor is still operational and follows the input. If the channel is in the ON state, parameters are no longer guaranteed and lifetime is reduced compared to the nominal supply voltage range. This especially impacts the short circuit robustness, as well as the maximum energy  $E_{AS}$  capability.  $Z_{GND}$ is recommended to be a resistor in series to a diode.

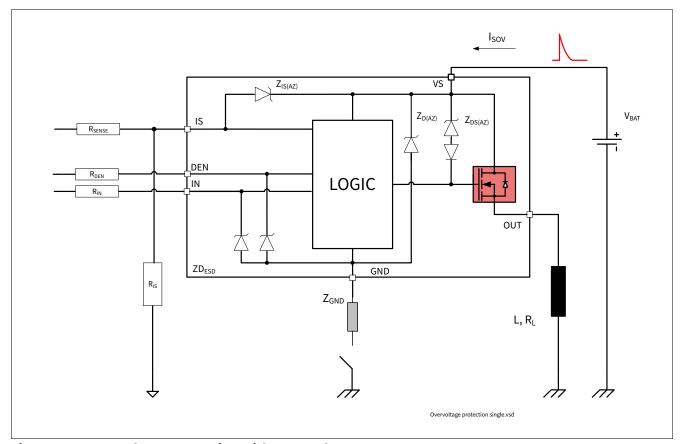


Figure 16 **Overvoltage Protection with External Components** 



#### 6.4 Reverse Polarity Protection

In case of reverse polarity, the intrinsic body diode of the power DMOS causes power dissipation. The current in this intrinsic body diode is limited by the load itself. Additionally, the current into the ground path and the logic pins has to be limited to the maximum current described in **Chapter 4.1** with an external resistor. **Figure 17** shows a typical application.  $R_{\text{GND}}$  resistor is used to limit the current in the Zener protection of the device. Resistors  $R_{\text{DEN}}$  and  $R_{\text{IN}}$  are used to limit the current in the logic of the device and in the ESD protection stage.  $R_{\text{SENSE}}$  is used to limit the current in the sense transistor which behaves as a diode. The recommended value for  $R_{\text{DEN}} = R_{\text{IN}} = R_{\text{SENSE}} = 10 \text{ k}\Omega$ . It is recommended to use a resistor in series to a diode in the ground path. During reverse polarity, no protection functions are available.

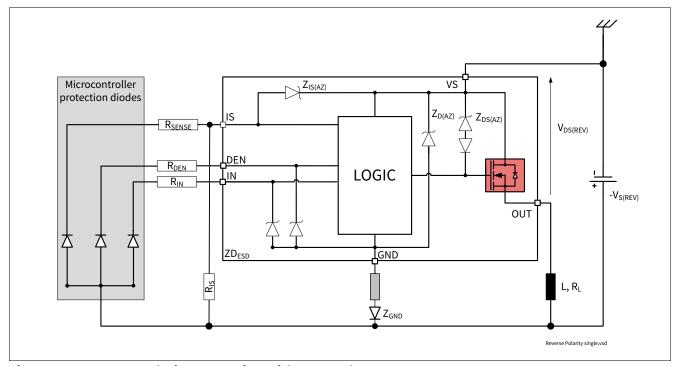


Figure 17 Reverse Polarity Protection with External Components

#### 6.5 Overload Protection

In case of overload, such as high inrush of cold lamp filament, or short circuit to ground, the BTS40K2-1ENC offers several protection mechanisms.

#### 6.5.1 Current Limitation

At first step, the instantaneous power in the switch is maintained at a safe value by limiting the current to the maximum current allowed in the switch  $I_{L(SC)}$ . During this time, the DMOS temperature is increasing, which affects the current flowing in the DMOS.

#### 6.5.2 Temperature Limitation in the Power DMOS

The channel incorporates both an absolute  $(T_{J(SC)})$  and a dynamic  $(T_{J(SW)})$  temperature sensor. Activation of either sensor will cause an overheated channel to switch OFF to prevent destruction. Any protective switch OFF latches the output until the temperature has reached an acceptable value. **Figure 18** gives a sketch of the situation.

A retry strategy is implemented such that when the DMOS temperature has cooled down enough, the switch is switched ON again, if the IN pin is still high (restart behavior).

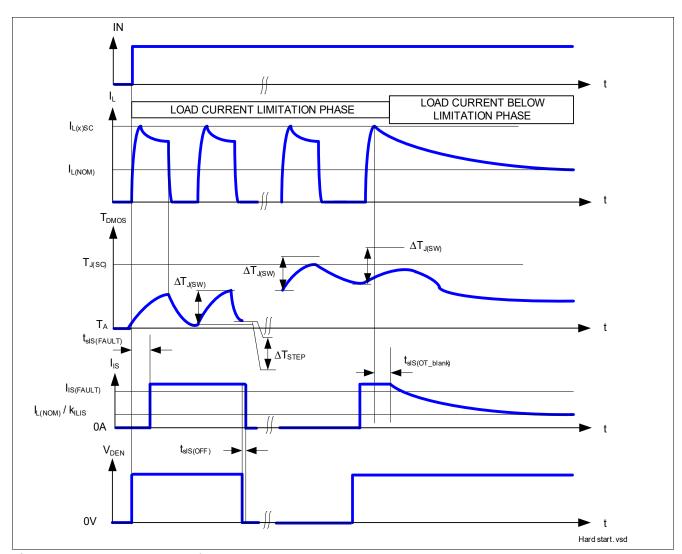


Figure 18 **Overload Protection** 

For better understanding, the time scale is not linear. The real timing of this drawing is application Note: dependant and cannot be described.

#### **Electrical Characteristics for the Protection Functions** 6.6

#### Table 7 **Electrical Characteristics: Protection**

 $V_S$  = 8 V to 18 V,  $T_A$  = -40°C to 150°C (unless otherwise specified).

Typical values are given at  $V_S = 13.5 \text{ V}$ ,  $T_J = 25 ^{\circ}\text{C}$ 

Parameter	Symbol		Values			Note or	Number
		Min.	Тур.	Max.		<b>Test Condition</b>	
Loss of Ground		1	l'	"	<b>'</b>		
Output leakage current while GND disconnected	I <sub>OUT (GND)</sub>	-	0.1	-	mA	<sup>1)2)</sup> V <sub>S</sub> = 28 V See <b>Figure 14</b>	P_6.6.1
Reverse Polarity		<u>'</u>					
Drain source diode voltage during reverse polarity	V <sub>DS (REV)</sub>	200	650	700	mV	3) I <sub>L</sub> = -1 A See <b>Figure 17</b>	P_6.6.2
Overvoltage		<u>'</u>					
Overvoltage protection	V <sub>S (AZ)</sub>	65	70	75	V	I <sub>SOV</sub> = 5 mA See <b>Figure 16</b>	P_6.6.3
Overload Condition		1	l'	"	<b>'</b>		
Load current limitation	I <sub>L5 (SC)</sub>	5	7	9	A	<sup>4)</sup> V <sub>DS</sub> = 5 V See <b>Figure 18</b>	P_6.6.4
Short circuit current during over temperature toggling	I <sub>L (RMS)</sub>	-	1.7	-	A	$V_{IN} = 4.5V$ $R_{SHORT} = 100 \text{ m}\Omega$ $L_{SHORT} = 5 \text{ μH}$	P_6.6.12
Dynamic temperature increase while switching	$\Delta T_{J(SW)}$	-	80	-	K	5) See <b>Figure 18</b>	P_6.6.8
Thermal shutdown temperature	T <sub>J (SC)</sub>	150	170 <sup>5)</sup>	200 <sup>5)</sup>	°C	3) See <b>Figure 18</b>	P_6.6.10
Thermal shutdown hysteresis	$\Delta T_{J(SC)}$	-	30	-	K	<sup>3) 5)</sup> See <b>Figure 18</b>	P_6.6.11

<sup>1)</sup> All pins are disconnected except VS and OUT.

<sup>2)</sup> Not Subject to production test, specified by design

<sup>3)</sup> Test at  $T_J = +150$ °C only

<sup>4)</sup> Test at  $T_J = -40^{\circ}$ C only

<sup>5)</sup> Functional test only

# infineon

#### **Diagnostic Functions**

## 7 Diagnostic Functions

For diagnosis purpose, the BTS40K2-1ENC provides a combination of digital and analog signals at pin IS. These signals are called SENSE. In case the diagnostic is disabled via DEN, pin IS becomes high impedance. In case DEN is activated, the sense current of the channel is enabled.

#### 7.1 IS Pin

The BTS40K2-1ENC provides a sense signal called  $I_{\rm IS}$  at pin IS. As long as no "hard" failure mode occurs (short circuit to GND / current limitation / overtemperature / excessive dynamic temperature increase or open load at OFF) a proportional signal to the load current (ratio  $k_{\rm ILIS} = I_{\rm L} / I_{\rm IS}$ ) is provided. The complete IS pin and diagnostic mechanism is described on **Figure 19**. The accuracy of the sense current depends on temperature and load current. Due to the ESD protection, in connection to  $V_{\rm S}$ , it is not recommended to share the IS pin with other devices if these devices are using another battery feed. The consequence is that the unsupplied device would be fed via the IS pin of the supplied device.

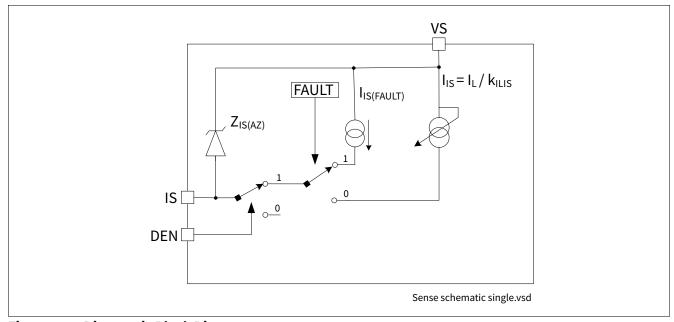


Figure 19 Diagnostic Block Diagram



#### **SENSE Signal in Different Operating Modes** 7.2

**Table 8** gives a quick reference for the state of the IS pin during device operation.

Sense Signal, Function of Operation Mode Table 8

Operation Mode	Input level Channel X	DEN	<b>Output Level</b>	<b>Diagnostic Output</b>
Normal operation	OFF	Н	Z	Z
Short circuit to GND			~ GND	Z
Overtemperature			Z	Z
Short circuit to V <sub>S</sub>			$V_{S}$	I <sub>IS(FAULT)</sub>
Open Load			$< V_{OL(OFF)} > V_{OL(OFF)}^{1)}$	Z I <sub>IS(FAULT)</sub>
Inverse current			~ V <sub>INV</sub>	I <sub>IS(FAULT)</sub>
Normal operation	ON		~ <i>V</i> <sub>S</sub>	$I_{\rm IS} = I_{\rm L} / k_{\rm ILIS}$
Current limitation			< <i>V</i> <sub>S</sub>	I <sub>IS(FAULT)</sub>
Short circuit to GND			~ GND	I <sub>IS(FAULT)</sub>
Overtemperature $T_{J(SW)}$ event			Z	I <sub>IS(FAULT)</sub>
Short circuit to V <sub>S</sub>			V <sub>S</sub>	$I_{\rm IS} < I_{\rm L} / k_{\rm ILIS}$
Open Load			~ V <sub>S</sub> <sup>2)</sup>	$I_{\rm IS} < I_{\rm IS(OL)}$
Inverse current			~ V <sub>INV</sub>	$I_{\rm IS} < I_{\rm IS(OL)}^{3)}$
Underload			~ V <sub>S</sub> <sup>4)</sup>	$I_{\rm IS(OL)} < I_{\rm IS} < I_{\rm L/kILIS}$
Don't care	Don't care	L	Don't care	Z

<sup>1)</sup> Stable with additional pull-up resistor.

<sup>2)</sup> The output current has to be smaller than  $I_{\text{L(OL)}}$ .

<sup>3)</sup> After maximum  $t_{INV}$ .

<sup>4)</sup> The output current has to be higher than  $I_{L(OL)}$ .



#### 7.3 SENSE Signal in the Nominal Current Range

**Figure 20** shows the current sense as a function of the load current in the power DMOS. Usually, a pull-down resistor  $R_{\rm IS}$  is connected to the current sense IS pin. This resistor has to be higher than 560 Ω to limit the power losses in the sense circuitry. A typical value is 1.2 kΩ. The blue curve represents the ideal sense current, assuming an ideal  $k_{\rm ILIS}$  factor value. The red curves shows the accuracy the device provides across full temperature range at a defined current.

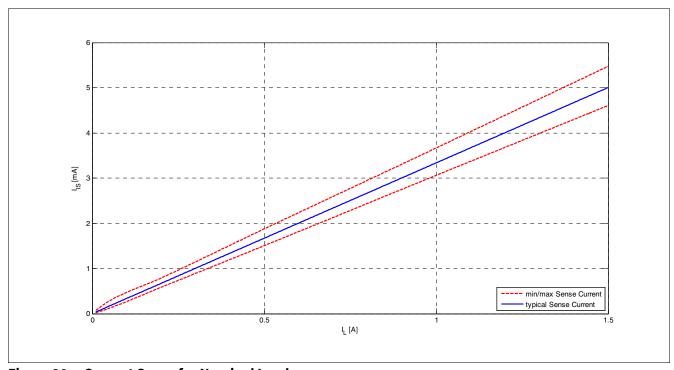


Figure 20 Current Sense for Nominal Load

### 7.3.1 SENSE Signal Variation as a Function of Temperature and Load Current

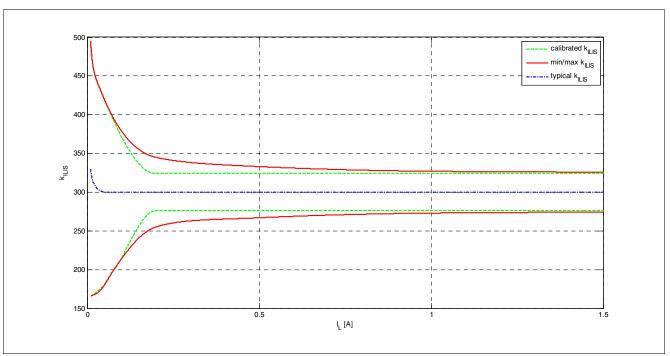
In some applications a better accuracy is required at smaller currents. To achieve this accuracy requirement, a calibration on the application is possible. To avoid multiple calibration points at different load and temperature conditions, the BTS40K2-1ENC allows limited derating of the  $k_{\rm ILIS}$  value, at a given point ( $I_{\rm L3}$ ;  $T_{\rm J}$  = +25°C). This derating is described by the parameter  $\Delta k_{\rm ILIS}$ . **Figure 21** shows the behavior of the sense current, assuming one calibration point at nominal load at +25°C.

The blue line indicates the ideal  $k_{\rm ILIS}$  ratio.

The red lines indicate the derating on the parameter across temperature and voltage, assuming one calibration point at nominal temperature and nominal battery voltage.

The black lines indicate the  $k_{\rm ILIS}$  accuracy without calibration.





**Improved Current Sense Accuracy with One Calibration Point** Figure 21

#### 7.3.2 **SENSE Signal Timing**

Figure 22 shows the timing during settling and disabling of the SENSE.

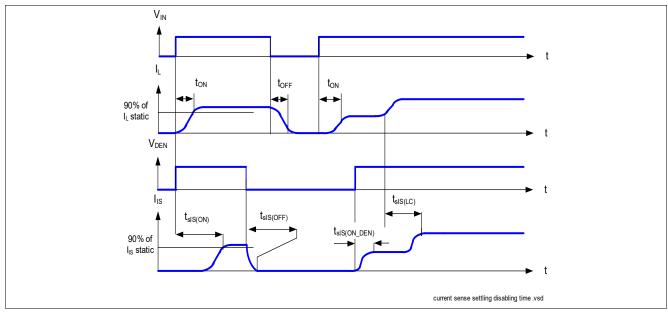


Figure 22 Current Sense Settling / Disabling Timing



#### 7.3.3 SENSE Signal in Open Load

#### 7.3.3.1 Open Load in ON Diagnostic

If the channel is ON, a leakage current can still flow through an open load, for example due to humidity. The parameter  $I_{L(OL)}$  gives the threshold of recognition for this leakage current. If the current  $I_L$  flowing out the power DMOS is below this value, the device recognizes a failure, if the DEN is selected. In that case, the SENSE current is below  $I_{IS(OL)}$ . Otherwise, the minimum SENSE current is given above parameter  $I_{IS(OL)}$ . Figure 23 shows the SENSE current behavior in this area. The red curve shows a typical product curve. The blue curve shows the ideal current sense.

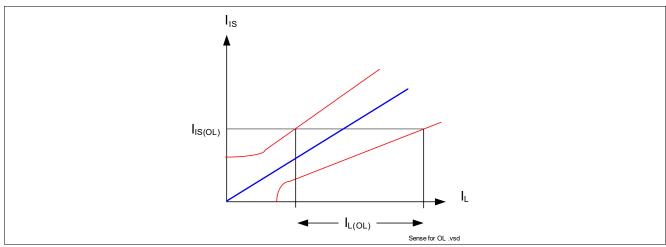


Figure 23 Current Sense Ratio for Low Currents

#### 7.3.3.2 Open Load in OFF Diagnostic

For open load diagnosis in OFF-state, an external output pull-up resistor ( $R_{\rm OL}$ ) is recommended. For the calculation of pull-up resistor value, the leakage currents and the open load threshold voltage  $V_{\rm OL(OFF)}$  have to be taken into account. **Figure 24** gives a sketch of the situation.  $I_{\rm leakage}$  defines the leakage current in the complete system, including  $I_{\rm L(OFF)}$  (see **Chapter 5.5**) and external leakages, e.g, due to humidity, corrosion, etc... in the application.

To reduce the stand-by current of the system, an open load resistor switch  $S_{OL}$  is recommended. If the channel is OFF, the output is no longer pulled down by the load and  $V_{OUT}$  voltage rises to nearly  $V_{S}$ . This is recognized by the device as an open load. The voltage threshold is given by  $V_{OL(OFF)}$ . In that case, the SENSE signal is switched to the  $I_{IS(FAULT)}$ .

An additional  $R_{PD}$  resistor can be used to pull  $V_{OUT}$  to 0 V. Otherwise, the OUT pin is floating. This resistor can be used as well for short circuit to battery detection, see **Chapter 7.3.4**.



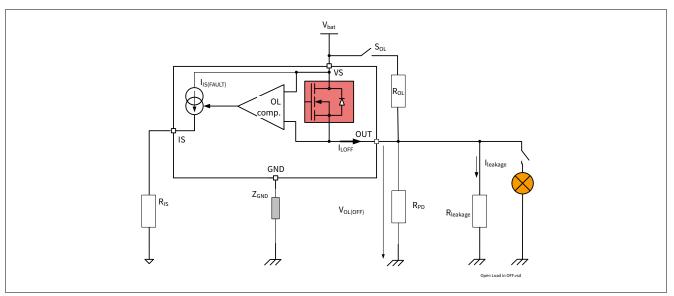


Figure 24 **Open Load Detection in OFF Electrical Equivalent Circuit** 

#### 7.3.3.3 **Open Load Diagnostic Timing**

Figure 25 shows the timing during either Open Load in ON or OFF condition when the DEN pin is HIGH. Please note that a delay  $t_{\text{sIS(FAULT-OL-OFF)}}$  has to be respected after the falling edge of the input, when applying an open load in OFF diagnosis request, otherwise the diagnosis can be wrong.

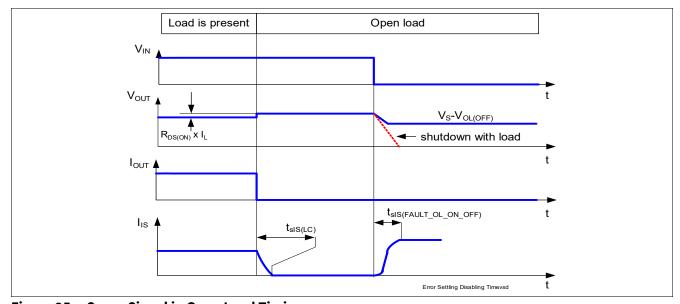


Figure 25 **Sense Signal in Open Load Timing** 

#### 7.3.4 SENSE Signal in Short Circuit to $V_s$

In case of a short circuit between the OUTput-pin and the  $V_s$  pin, all or portion (depending on the short circuit impedance) of the load current will flow through the short circuit. As a result, a lower current compared to the normal operation will flow through the DMOS of the BTS40K2-1ENC, which can be recognized at the current sense signal. The open load at OFF detection circuitry can also be used to distinguish a short circuit to  $V_s$ . In that case, an external resistor to ground  $R_{SC\ VS}$  is required. Figure 26 gives a sketch of the situation.



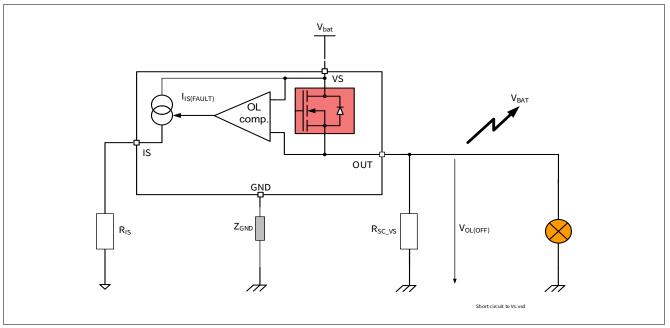


Figure 26 Short Circuit to Battery Detection in OFF Electrical Equivalent Circuit

#### 7.3.5 SENSE Signal in Case of Overload

An overload condition is defined by a current flowing out of the DMOS reaching the current limitation and / or the absolute dynamic temperature swing  $T_{J(SW)}$  is reached, and / or the junction temperature reaches the thermal shutdown temperature  $T_{J(SC)}$ . Please refer to **Chapter 6.5** for details.

In that case, the SENSE signal given is by  $I_{\rm IS(FAULT)}$  when the diagnostic is selected.

The device has a thermal restart behavior, such that when the overtemperature or the exceed dynamic temperature condition has disappeared, the DMOS is reactivated if the IN is still at logic level one. If the DEN pin is activated the SENSE is not toggling with the resstart mechanism and remains to  $I_{\rm IS(FAULT)}$ .

### 7.3.6 SENSE Signal in Case of Inverse Current

In the case of inverse current, the sense signal will indicate open load in OFF state and indicate open load in ON state.



#### **Electrical Characteristics Diagnostic Function** 7.4

## **Electrical Characteristics: Diagnostics**

 $V_S = 8 \text{ V to } 18 \text{ V}$ ,  $T_A = -40 ^{\circ}\text{C}$  to 150  $^{\circ}\text{C}$  (unless otherwise specified). Typical values are given at  $V_S = 13.5 \text{ V}$ ,  $T_J = 25^{\circ}\text{C}$ 

Parameter	Symbol		Value	s	Unit	Note or	Number
		Min.	Тур.	Max.		Test Condition	
<b>Load Condition Threshold</b>	for Diagnos	tic					
Open load detection threshold in OFF state	V <sub>S</sub> -V <sub>OL (OFF)</sub>	4	_	6	V	$V_{IN} = 0 \text{ V}$ $V_{DEN} = 4.5 \text{ V}$ See <b>Figure 25</b>	P_7.5.1
Open load detection threshold in ON state	I <sub>L (OL)</sub>	5	_	15	mA	$V_{IN} = V_{DEN} = 4.5 \text{ V}$ $I_{IS(OL)} = 33 \mu\text{A}$ See <b>Figure 23</b>	P_7.5.2
Sense Pin							
IS pin leakage current when sense is disabled	I <sub>IS_(DIS)</sub>	_	0.02	1	μΑ	$V_{IN} = 4.5 \text{ V}$ $V_{DEN} = 0 \text{ V}$ $I_{L} = I_{L4} = 1 \text{ A}$	P_7.5.4
Sense signal saturation voltage	V <sub>S</sub> - V <sub>IS</sub> (RANGE)	1	-	3.5	V	$V_{IN} = 0 \text{ V}$ $V_{OUT} = V_{S} > 10 \text{ V}$ $V_{DEN} = 4.5 \text{ V}$ $V_{IS} = 6 \text{ mA}$	P_7.5.6
Sense signal maximum current in fault condition	I <sub>IS (FAULT)</sub>	6	15	35	mA	$V_{IS} = V_{IN} = V_{DSEL} = 0 \text{ V}$ $V_{OUT} = V_S > 10 \text{ V}$ $V_{DEN} = 4.5 \text{ V}$ See <b>Figure 19</b>	P_7.5.7
Sense pin maximum voltage $V_{\rm S}$ to $I_{\rm S}$	V <sub>IS (AZ)</sub>	65	70	75	V	I <sub>IS</sub> = 5 mA See <b>Figure 19</b>	P_7.5.3
<b>Current Sense Ratio Signa</b>	l in the Nom	inal Are	a, Stable	e Load Cu	ırrent C	Condition	
Current sense ratio $I_{L0} = 10 \text{ mA}$	k <sub>ILISO</sub>	-50%	330	+50%		$V_{IN} = 4.5 \text{ V}$ $V_{DEN} = 4.5 \text{ V}$	P_7.5.8
Current sense ratio $I_{L1} = 0.05 \text{ A}$	k <sub>ILIS1</sub>	-40%	300	+40%		See <b>Figure 20</b> $T_{J} = -40^{\circ}\text{C}; 150^{\circ}\text{C}$	P_7.5.9
Current sense ratio I <sub>L2</sub> = 0.2 A	k <sub>ILIS2</sub>	-15%	300	+15%			P_7.5.10
Current sense ratio I <sub>L3</sub> = 0.5 A	k <sub>ILIS3</sub>	-11%	300	+11%			P_7.5.11
Current sense ratio I <sub>L4</sub> = 1 A	k <sub>ILIS4</sub>	-9%	300	+9%			P_7.5.12
k <sub>ILIS</sub> de-rating with current and temperature	$\Delta k_{ILIS}$	-5	0	+5	%	<sup>2)</sup> k <sub>ILIS3</sub> versus k <sub>ILIS2</sub> See <b>Figure 21</b>	P_7.5.17

# infineon

#### **Diagnostic Functions**

## Table 9 Electrical Characteristics: Diagnostics (cont'd)

 $V_{\rm S}$  = 8 V to 18 V,  $T_{\rm J}$  = -40°C to 150°C (unless otherwise specified). Typical values are given at  $V_{\rm S}$  = 13.5 V,  $T_{\rm J}$  = 25°C

Parameter	Symbol	Values			Unit	Note or	Number
		Min.	Тур.	Max.		<b>Test Condition</b>	
<b>Diagnostic Timing in Norm</b>	al Condition	i I		·	·		
Current sense settling time to $k_{\rm ILIS}$ function stable after positive input slope on both INput and DEN	ts <sub>IS (ON)</sub>	-	-	150	μs	$V_{DEN} = V_{IN} = 0$ to 4.5 V $V_{S} = 13.5$ V $R_{IS} = 1.2$ kΩ $C_{SENSE} < 100$ pF $I_{L} = I_{L3} = 0.5$ A See <b>Figure 22</b>	P_7.5.18
Current sense settling time with load current stable and transition of the DEN	ts <sub>IS (ON_DEN)</sub>	-	_	10	μs	$V_{IN}$ = 4.5 V $V_{DEN}$ = 0 to 4.5 V $R_{IS}$ = 1.2 k $\Omega$ $C_{SENSE}$ < 100 pF $I_{L}$ = $I_{L3}$ = 0.5 A See <b>Figure 22</b>	P_7.5.19
Current sense settling time to I <sub>IS</sub> stable after positive input slope on current load	ts <sub>IS (LC)</sub>	_	-	15	μs	$V_{IN} = 4.5 \text{ V}$ $V_{DEN} = 4.5 \text{ V}$ $R_{IS} = 1.2 \text{ k}\Omega$ $C_{SENSE} < 100 \text{ pF}$ $I_{L=IL2} = 0.2 \text{ A to}$ $I_{L} = I_{L3} = 0.5 \text{ A}$ See Figure 22	P_7.5.20
<b>Diagnostic Timing in Open</b>	<b>Load Condit</b>	ion					
Current sense settling time to I <sub>IS</sub> stable for open load detection in OFF state	ts <sub>IS</sub> (FAULT_OL_OFF)	-	-	50	μs	$V_{IN} = 0 \text{ V}$ $V_{DEN} = 0 \text{ to } 4.5 \text{ V}$ $R_{IS} = 1.2 \text{ k}\Omega$ $C_{SENSE} < 100 \text{ pF}$ $V_{OUT} = V_S = 13.5 \text{ V}$ See <b>Figure 25</b>	P_7.5.22
Current sense settling time to I <sub>IS</sub> stable for open load detection in ON-OFF transition	ts <sub>IS</sub> (FAULT_OL_ON_OFF)	-	200	-	μs	$V_{IN}$ = 4.5 to 0 V $V_{DEN}$ =4.5 V $R_{IS}$ = 1.2 kΩ $C_{SENSE}$ < 100 pF $V_{OUT}$ = $V_{S}$ = 13.5 V	P_7.5.23
Diagnostic Timing in Over	oad Condition	on					
Current sense settling time to I <sub>IS</sub> stable for overload detection	ts <sub>IS (FAULT)</sub>	_	_	150	μѕ	<sup>1)</sup> $V_{IN} = V_{DEN} = 0$ to 4.5 V $R_{IS} = 1.2$ kΩ $C_{SENSE} < 100$ pF $V_{DS} = 5$ V See <b>Figure 18</b>	P_7.5.24

## PROFET™ +24 V

#### BTS40K2-1ENC



#### **Diagnostic Functions**

## Table 9 Electrical Characteristics: Diagnostics (cont'd)

 $V_{\rm S}$  = 8 V to 18 V,  $T_{\rm J}$  = -40°C to 150°C (unless otherwise specified).

Typical values are given at  $V_S = 13.5 \text{ V}$ ,  $T_J = 25 ^{\circ}\text{C}$ 

Parameter	Symbol	Values			Unit	Note or	Number
		Min.	Тур.	Max.		Test Condition	
Current sense over temperature blanking time	t <sub>sIS(OT_blank)</sub>	-	350	-	μs	$V_{IN} = V_{DEN} = 4.5 \text{ V}$ $R_{IS} = 1.2 \text{ k}\Omega$ $C_{SENSE} < 100 \text{ pF}$ $V_{DS} = 5 \text{ V to 0 V}$ See <b>Figure 18</b>	P_7.5.32
Diagnostic disable time DEN transition to $I_{\rm IS} < 50\% I_{\rm L}/k_{\rm ILIS}$	ts <sub>IS (OFF)</sub>	_	_	20	μs	$V_{IN} = 4.5 \text{ V}$ $V_{DEN} = 4.5 \text{ V}$ to 0 V $R_{IS} = 1.2 \text{ k}\Omega$ $C_{SENSE} < 100 \text{ pF}$ $I_{L} = I_{L3} = 0.5 \text{ A}$ See Figure 22	P_7.5.25

<sup>1)</sup> Test at  $T_J = -40^{\circ}$ C only

<sup>2)</sup> Not subject to production test, specified by design

**Input Pins** 



## 8 Input Pins

## 8.1 Input Circuitry

The input circuitry is compatible with 3.3 V and 5 V microcontrollers. The concept of the input pin is to react to voltage thresholds. An implemented Schmitt trigger avoids any undefined state if the voltage on the input pin is slowly increasing or decreasing. The output is either OFF or ON but cannot be in a linear or undefined state. The input circuitry is compatible with PWM applications. **Figure 27** shows the electrical equivalent input circuitry. In case the pin is not needed, it must be left opened, or must be connected to device ground (and not module ground) via an  $10 \text{ k}\Omega$  input resistor.

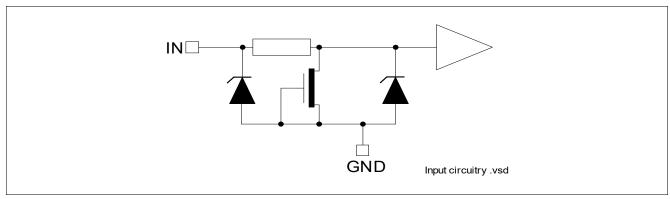


Figure 27 Input Pin Circuitry

#### 8.2 DEN Pin

The DEN pins enable and disable the diagnostic functionality of the device. This pin has the same structure as the INput pin, please refer to **Figure 27**.

#### 8.3 Input Pin Voltage

The IN and DEN use a comparator with hysteresis. The switching ON / OFF takes place in a defined region, set by the thresholds  $V_{\rm IN(L)}$  Max. and  $V_{\rm IN(H)}$  Min. The exact value where the ON and OFF take place are unknown and depends on the process, as well as the temperature. To avoid cross talk and parasitic turn ON and OFF, a hysteresis is implemented. This ensures a certain immunity to noise.



**Input Pins** 

### 8.4 Electrical Characteristics

#### Table 10 Electrical Characteristics: Input Pins

 $V_{\rm S}$  = 8 V to 18 V,  $T_{\rm J}$  = -40°C to 150°C (unless otherwise specified). Typical values are given at  $V_{\rm S}$  = 13.5 V,  $T_{\rm J}$  = 25°C

Parameter	Symbol	Values			Unit	Note or	Number
		Min.	Тур.	Max.		<b>Test Condition</b>	
INput Pin Characteristics		1	1	-			<u>'</u>
Low level input voltage range	V <sub>IN (L)</sub>	-0.3	-	0.8	٧		P_8.4.1
High level input voltage range	V <sub>IN (H)</sub>	2	_	6	٧		P_8.4.2
Input voltage hysteresis	V <sub>IN (HYS)</sub>	_	250	_	mV	1)	P_8.4.3
Low level input current	I <sub>IN (L)</sub>	1	10	25	μΑ	V <sub>IN</sub> = 0.8 V	P_8.4.4
High level input current	I <sub>IN (H)</sub>	2	10	25	μΑ	V <sub>IN</sub> = 5.5 V	P_8.4.5
DEN Pin			<u> </u>		•		
Low level input voltage range	V <sub>DEN (L)</sub>	-0.3	_	0.8	٧	_	P_8.4.6
High level input voltage range	V <sub>DEN (H)</sub>	2	-	6	٧	_	P_8.4.7
Input voltage hysteresis	V <sub>DEN (HYS)</sub>	_	250	_	mV	1)	P_8.4.8
Low level input current	I <sub>DEN (L)</sub>	1	10	25	μΑ	V <sub>DEN</sub> = 0.8 V	P_8.4.9
High level input current	I <sub>DEN (H)</sub>	2	10	25	μΑ	V <sub>DEN</sub> = 5.5 V	P_8.4.10

<sup>1)</sup> Not subject to production test, specified by design

#### **Application Information**



## 9 Application Information

Note:

The following information is given as a hint for the implementation of the device only and shall not be regarded as a description or warranty of a certain functionality, condition or quality of the device.

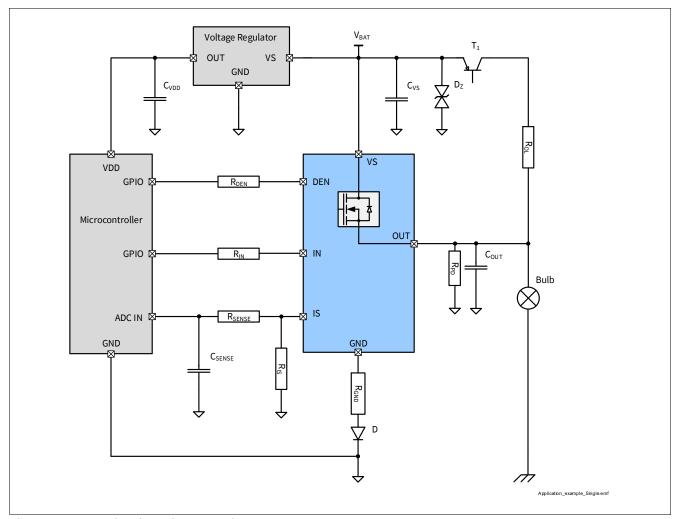


Figure 28 Application Diagram with BTS40K2-1ENC

Note: This is a very simplified example of an application circuit. The function must be verified in the real application.

# infineon

#### **Application Information**

Table 11 Bill of Material

Reference	Value	Purpose
R <sub>IN</sub>	10 kΩ	Protection of the microcontroller during overvoltage, reverse polarity Guarantee BTS40K2-1ENC channel is OFF during loss of ground
$R_{DEN}$	10 kΩ	Protection of the microcontroller during overvoltage, reverse polarity
R <sub>PD</sub>	47 kΩ	Polarization of the output for short circuit to $V_S$ detection Improve BTS40K2-1ENC immunity to electomagnetic noise
R <sub>ROL</sub>	1.5 kΩ	Ensures polarization of the BTS40K2-1ENC output during open load in OFF diagnostic
R <sub>IS</sub>	1.2 kΩ	Sense resistor
R <sub>SENSE</sub>	10 kΩ	Overvoltage, reverse polarity, loss of ground. Value to be tuned with microcontroller specification.
$C_{SENSE}$	100 pF	Sense signal filtering.
C <sub>OUT</sub>	10 nF	Protection of the device during ESD and BCI
$R_{GND}$	27 Ω	Protection of the BTS40K2-1ENC during overvoltage
D	BAS21	Protection of the BTS40K2-1ENC during reverse polarity
Z	58 V Zener diode	Protection of the device during overvoltage
$C_{\text{VS}}$	100 nF	Filtering of voltage spikes at the battery line
$\overline{T_1}$	BC 807	Switch the battery voltage for open load in OFF diagnostic

## 9.1 Further Application Information

- Please contact us to get the pin FMEA
- Existing App. Notes
- For further information you may visit www.infineon.com

#### **Package Outlines**



## 10 Package Outlines

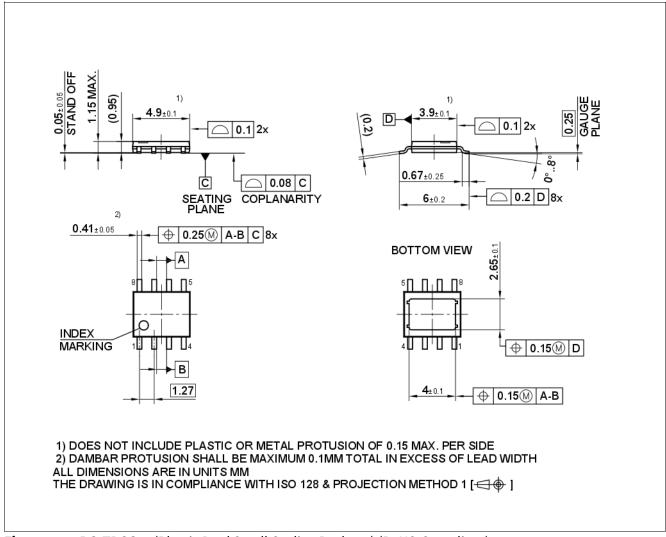


Figure 29 PG-TDSO-8 (Plastic Dual Small Outline Package) (RoHS-Compliant)

#### **Green Product (RoHS compliant)**

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).



**Revision History** 

#### **Revision History** 11

Version	Date	Changes
1.01	2020-07-15	Title correction: 12 V → 24 V
		Title correction: BTS40k2-1ENC → BTS40K2-1ENC
1.0	2018-05-14	Creation of the document



## **Table of Contents**

1	Overview	. 1
2	Block Diagram	. 3
3.1 3.2 3.3	Pin Configuration         Pin Assignment         Pin Definitions and Functions         Voltage and Current Definition	. 4
4.1 4.2 4.3 4.3.1 4.3.2	General Product Characteristics Absolute Maximum Ratings Functional Range Thermal Resistance PCB set up Thermal Impedance	. 8
5.1 5.2 5.3 5.3.1 5.3.2 5.4 5.5	Power Stage Output ON-State Resistance Turn ON/OFF Characteristics with Resistive Load Inductive Load Output Clamping Maximum Load Inductance Inverse Current Capability Electrical Characteristics Power Stage	11 12 12 13 14
6.1 6.2 6.3 6.4 6.5 6.5.1 6.5.2 6.6	Protection Functions  Loss of Ground Protection  Undervoltage Protection  Overvoltage Protection  Reverse Polarity Protection  Overload Protection  Current Limitation  Temperature Limitation in the Power DMOS  Electrical Characteristics for the Protection Functions	17 18 19 19 19
7.1 7.2 7.3 7.3.1 7.3.2 7.3.3 7.3.3.1 7.3.3.2 7.3.3.3 7.3.4 7.3.5 7.3.6 7.4	Diagnostic Functions  IS Pin  SENSE Signal in Different Operating Modes  SENSE Signal in the Nominal Current Range  SENSE Signal Variation as a Function of Temperature and Load Current  SENSE Signal Timing  SENSE Signal in Open Load  Open Load in ON Diagnostic  Open Load Diagnostic Timing  SENSE Signal in Short Circuit to V <sub>S</sub> SENSE Signal in Case of Overload  SENSE Signal in Case of Inverse Current  Electrical Characteristics Diagnostic Function	222 233 244 255 266 266 277 277 288 289
<b>8</b> 3.1	Input Pins	



8.2	DEN Pin	32
8.3	Input Pin Voltage	32
8.4	Electrical Characteristics	33
9	Application Information	34
9.1	Further Application Information	35
10	Package Outlines	36
11	Revision History	37
	Table of Contents	38

#### **Trademarks of Infineon Technologies AG**

µHVIC™, µIPM™, µPFC™, AU-ConvertIR™, AURIX™, C166™, Canpak™, CIPOS™, CIPURSE™, CoolDp™, CoolGan™, COOLiR™, CoolMos™, CoolSic™, Dave™, DI-POL™, DirectFet™, DrBlade™, EasyPIM™, EconoBridge™, EconoDual™, EconoPack™, EconoPim™, EiceDriver™, eupec™, FCOS™, Ganpowir™, HEXFET™, HITFET™, HybridPack™, iMOTIOn™, IRam™, ISOFace™, Isopack™, LeDrivir™, Litix™, Mipaq™, ModStack™, my-d™, Novalithic™, Optiga™, Optimos™, Origa™, Powirstage™, PrimePack™, PrimeStack™, Profet™, Pro-Sil™, Rasic™, Real3™, SmartLewis™, Solid Flash™, Spoc™, Strongirfet™, Supirbuck™, Tempfet™, Trenchstop™, Tricore™, UHVic™, XHP™, XMc™.

Trademarks updated November 2015

#### **Other Trademarks**

All referenced product or service names and trademarks are the property of their respective owners.

Edition 2020-07-20 Published by Infineon Technologies AG 81726 Munich, Germany

© 2020 Infineon Technologies AG. All Rights Reserved.

Do you have a question about any aspect of this document?

Email: erratum@infineon.com

Document reference BTS40K2-1ENC

#### IMPORTANT NOTICE

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

#### **Legal Disclaimer for Short-Circuit Capability**

Infineon disclaims any warranties and liablilities, whether expressed or implied, for any short-circuit failures below the threshold limit.

For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office (www.infineon.com).

#### WARNINGS

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.

## **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Power Switch ICs - Power Distribution category:

Click to view products by Infineon manufacturer:

Other Similar products are found below:

TLE6232GP NCP45520IMNTWG-L VND5E004ATR-E VND5004ASP30TR-E FPF1018 DS1222 BSP762TXT NCV380HMUAJAATBG
TCK2065G,LF SZNCP3712ASNT3G NCP45520IMNTWG-H VND5004ATR-E ITS5215LXT AP22811BW5-7 SLG5NT1437VTR
SZNCP3712ASNT1G DML1008LDS-7 KTS1640QGDV-TR KTS1641QGDV-TR TS13011-QFNR BTS70401EPZXUMA1
NCV459MNWTBG NCP4545IMNTWG-L NCV8412ASTT3G BTT3018EJXUMA1 FPF2260ATMX SLG5NT1765V SLG5NT1757V
NCP45780IMN24RTWG AP2151AMP-13 NCP45540IMNTWG-L TPS2022P FPF2495BUCX NCP45650IMNTWG NCV8412ADDR2G
DK5V100R20S BTS7020-2EPA BTT6100-2ERA BTS71220-4ESA DK5V100R15M WS3220C9-9/TR AW32405CSR BTT6030-2ERA
TLE75602-ESH BTS5200-4EKA DK5V150R25M DK5V45R25 DK5V100R25S AW35206FOR BTS7120-2EPA